

PRODUCT DATASHEET

Analog MEMS Microphone

For Active Noise Cancellation

IM2819B381-N44A

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1. Introduction

1.1 Overview

IM2819B381-N44A is an analog bottom port MEMS microphone with high performance and reliability. The IM2819B381-N44A integrates a MEMS microphone element, an impedance converter, and an output amplifier.

Other high-performance specifications include 130 dB SPL acoustic overload point in high performance mode, ± 1 dB sensitivity tolerance and enhanced immunity to both radiated and conducted RF interface.

Excellent acoustic performance, along with the compact size(2.75*1.85*0.95mm) is best-suited for a wide range of consumer electronic products, offering a product with high-quality to meet the application requirement.

1.2 Product Features

- Omnidirectional
- Small Size
- High AOP
- RF Protection
- HD Voice MEMS Microphone
- RoHS/Halogen free compliant
- Standard SMD Reflow

1.3 Typical Application

- ANC headphones
- Bluetooth headset
- Cameras
- Wearable intelligent equipment
- Portable electronics

2. Absolute Maximum Ratings

Parameter	Absolute Maximum Rating	Units
Voltage Range of VDD to Ground	-0.3 to +3.9	V
Voltage Range of Output to Ground	-0.3 to +3.9	V
Input Current to Any Pin	± 5	mA
Temperature Range	-40 to +100	°C

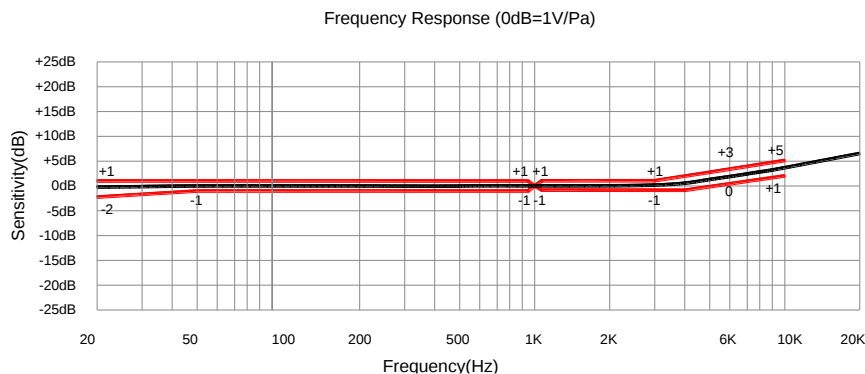
Stresses exceeding these “Absolute Maximum Ratings” could cause permanent damage to the microphone. These are stress rating only. Functional operation at these or any other conditions beyond those indicated under “Absolute and Electrical Characteristics” is not implied. Exposure beyond those indicated under “Acoustic and Electrical Characteristics” for extended periods may affect microphone reliability.

3. Acoustic and Electrical Characteristics

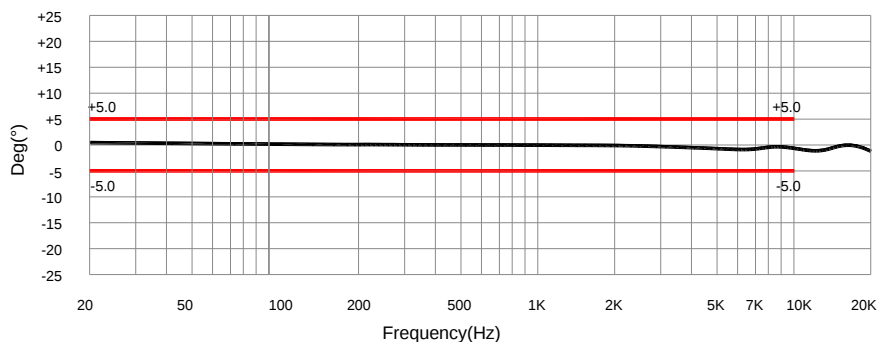
(Test Conditions: 23±2°C, 55±20% R.H)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Directivity	D(θ)	Omni-Directional				
Sensitivity	S	94dB SPL @1KHz	-39	-38	-37	dBV/Pa
Supply Voltage	V _{DD}		1.6	2.0	3.6	V
Current Consumption	I _{DSS}	V _{DD} =2.0V			250	μA
S/N Ratio	S/N	BW=20-20KHz (A-weighted)		65		dB(A)
Total Harmonic Distortion	THD	94dB SPL @1KHz		0.10		%
Acoustic Overload Point	AOP	10% THD @ 1 kHz VDD=2.3~3.6V		130		dB SPL
Power Supply Rejection Ratio	PSRR	200mVpp sinewave @ 1kHz, VDD = 2.0V		75		dB
Power Supply Rejection	PSR	100 mVpp square wave @ 217 Hz, VDD = 2.0V,		-105		dBV(A)
Output Impedance	Zout	@1KHz			300	Ω
DC Output				1.0		V

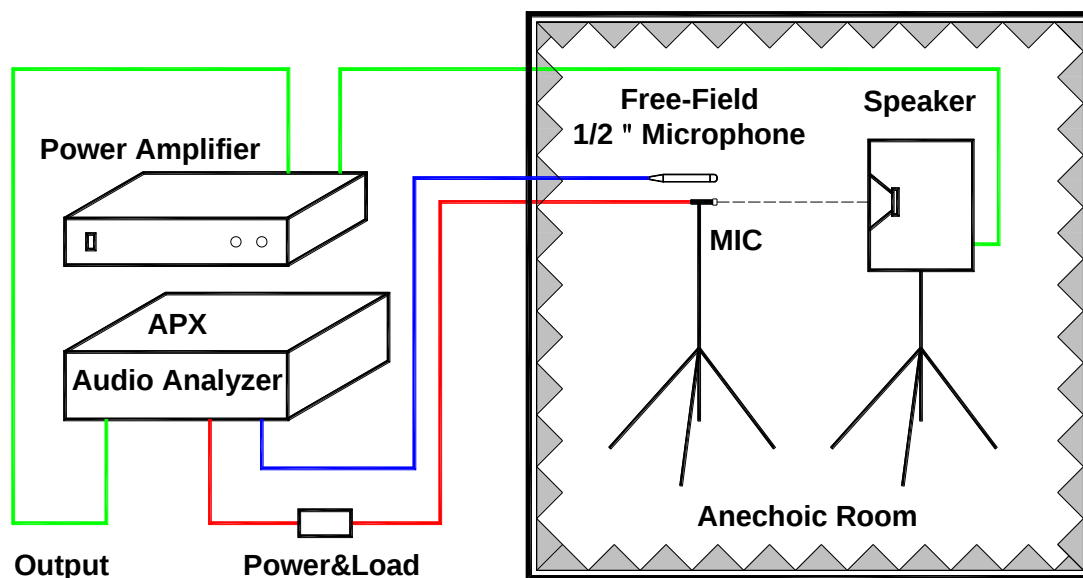
4. Frequency Response Curve



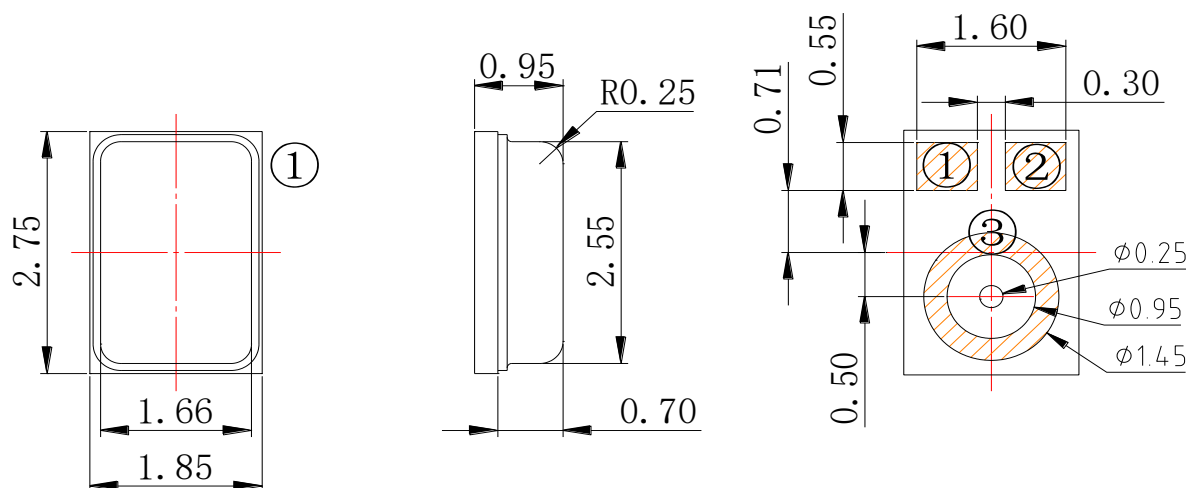
Phase



5. Test Setup Drawing



6. Mechanical Specifications



Item	Dimension	Tolerance	Units
Length(L)	2.75	±0.10	mm
Width(W)	1.85	±0.10	mm
Height(H)	0.95	±0.10	mm
Acoustic port(AP)	Φ0.25	±0.10	mm

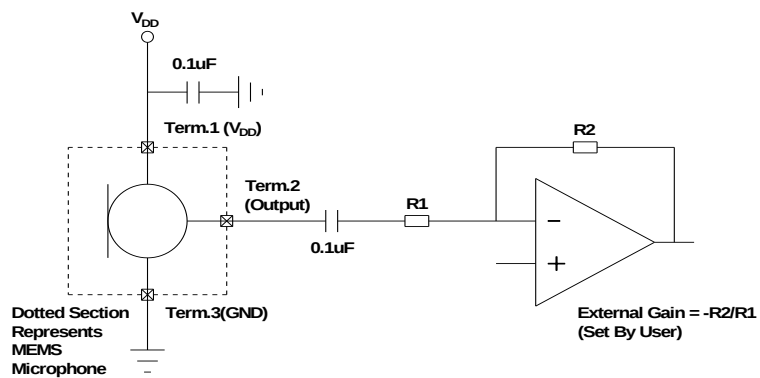
Pin Output	
Pin#	Function
1	V _{DD}
2	Output
3	GND

Note:

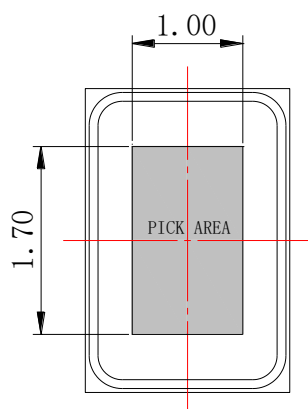
All dimensions are in millimeter(mm).

Tolerance: +/-0.1mm unless otherwise specified.

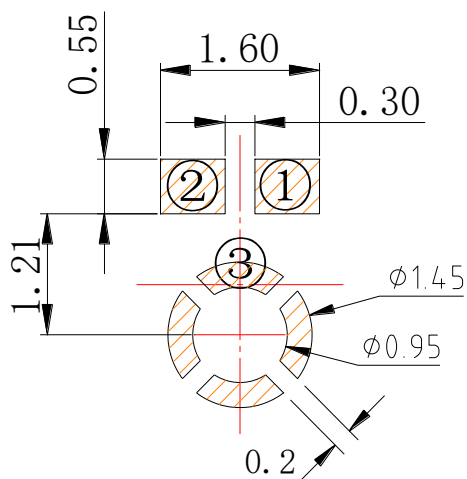
7. Recommended Interface Circuit



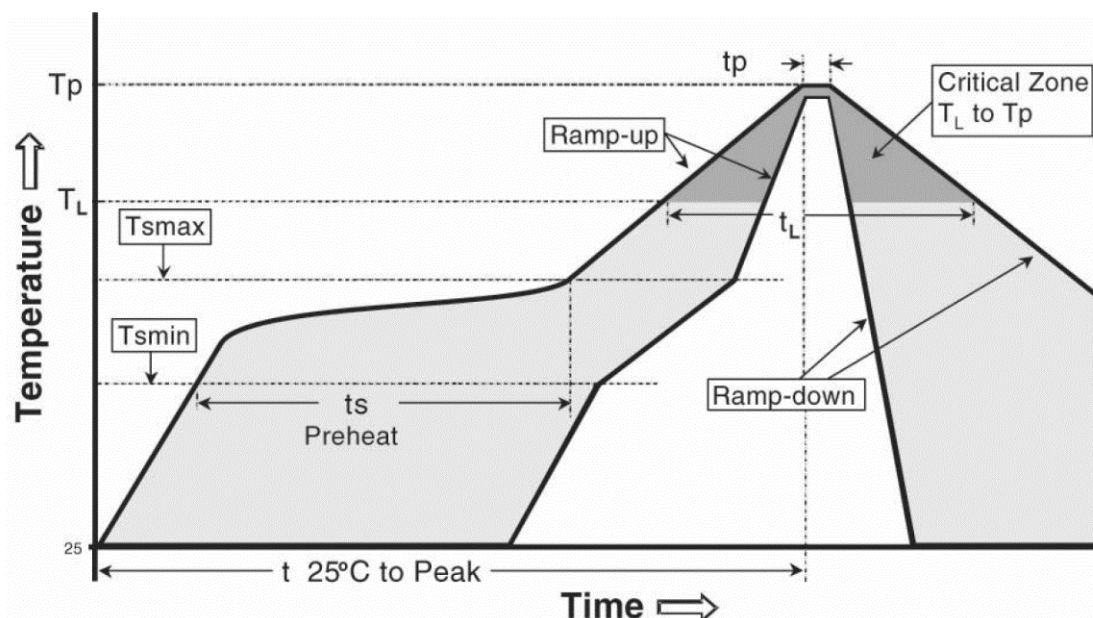
8. Vacuum nozzle pickup location



9. Example solder stencil pattern



10. Recommended Reflow Profile



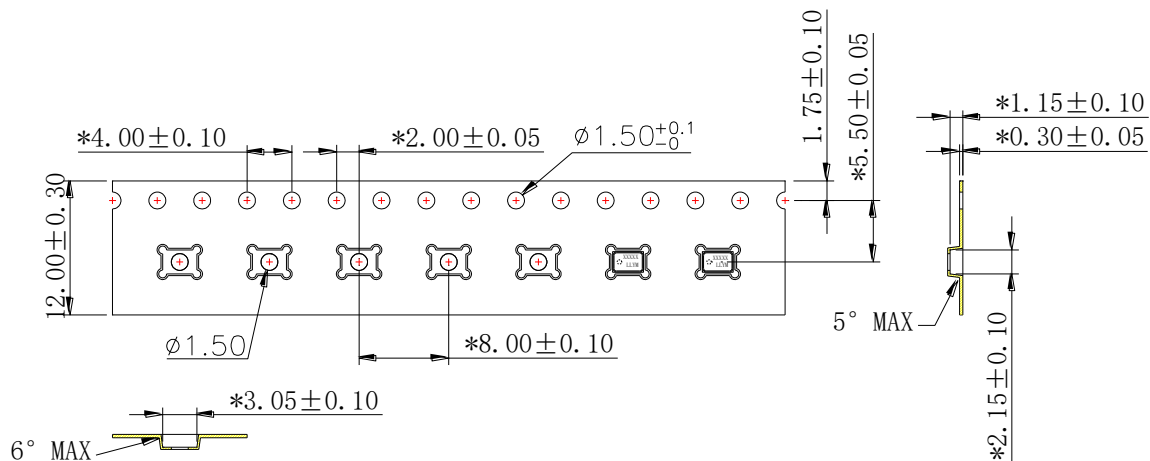
Profile Feature	Pb-Free
Average Ramp-up rate (T _{smax} to T _p)	3°C/second max.
Preheat	
Temperature Min (T _{smin})	150°C
Temperature Max (T _{smax})	200°C
Time (T _{SMIN} to T _{SMAX}) (t _s)	60-180 seconds
Time maintained above:	
Temperature (T _L)	217°C
Time (t _L)	60-150 seconds
Peak Temperature (T _p)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down rate(T _p to T _{smax})	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Notes:

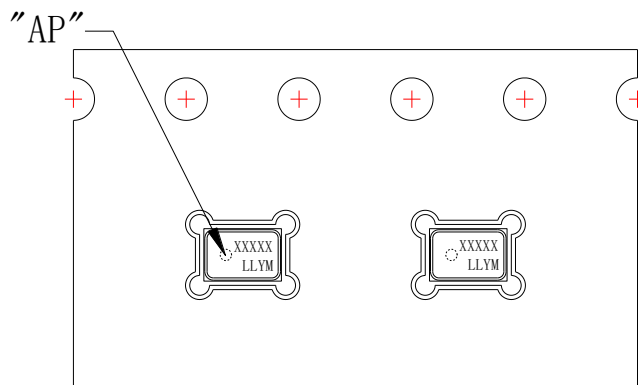
1. Pulling vacuum over acoustical hole of the microphone is not allowed, because the device can be damaged by vacuum.
2. Wash the board after reflow process is not allowed, because board washing and cleaning agents can damage the device. Device should not be exposed to ultrasonic processing or cleaning.
3. Recommended number of reflow is no more than 3 times.

11. Packaging Specifications

11.1. Tape Specification

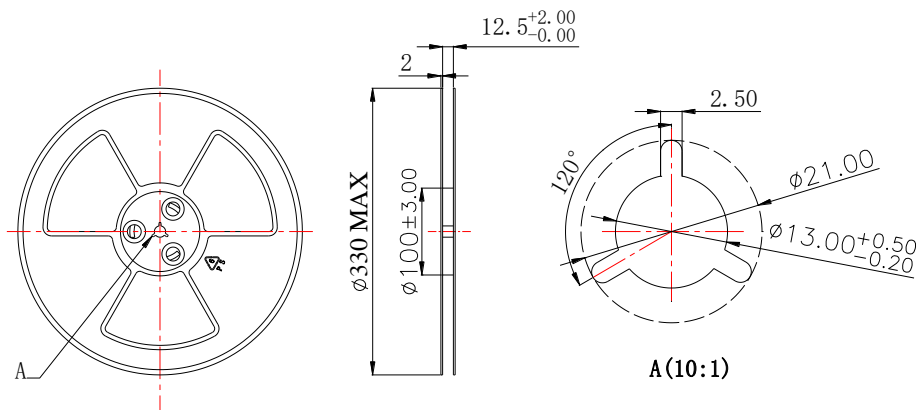


Line	Character	Description
1	XXXXXX	Unique Trace Code
2	LL	Identify Code
3	Y	Year
4	M	Month

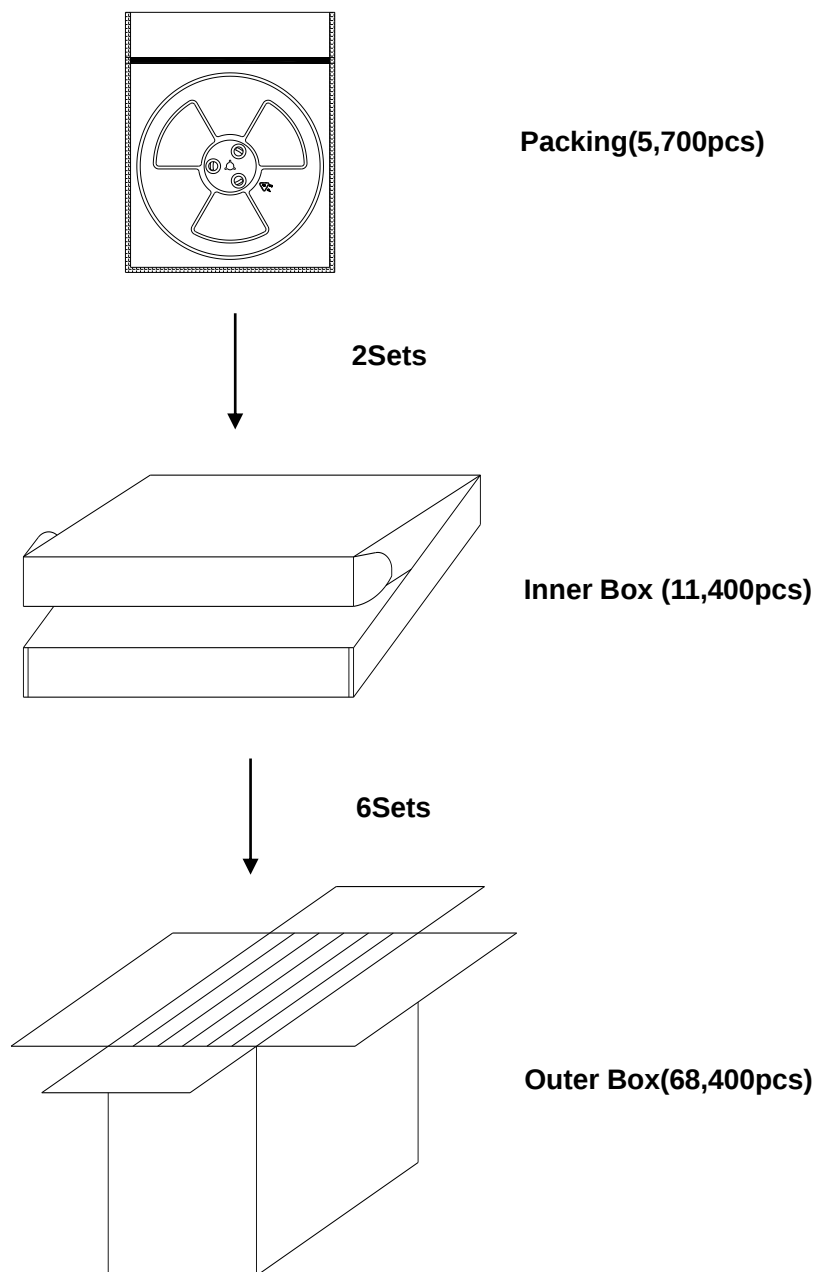


11.2. Reel Dimension

13" reel dimensions (unit:mm)



11.3. The Content of Box(13" reel)



Qty/ Reel	Qty/ One Inner Box	Qty/ Outer Box (Six Inner Box)
5,700 pcs	11,400 pcs	68,400 pcs
Φ 330mm	355×340×45mm	365×290×370mm

12. Reliability Specifications

Test Item	Detail
Thermal Shock	100 cycles of air-air thermal shock from -40°C to +105°C with 15 minute soaks.
High Temperature Storage	+105°C environment for 500 hours.
Low Temperature Storage	-40°C environment for 500 hours.
High Temperature Test	+105°C environment while under bias for 500 hours.
Low Temperature Test	-40°C environment while under bias for 500 hours.
Humidity Test	+85°C/85% R.H. environment while under bias for 500 hours.
Vibration Test	16 minutes in each X, Y, Z axis from 20 to 2,000 Hz with peak acceleration of 20G.
Drop Test	1.5-meter height onto a concrete surface each time at three directions in state of packaging.
Reflow Test	5 reflow cycles with peak temperature of +260°C.
ESD Test	Under C=150pF, R=330ohm. Tested to $\pm 8\text{KV}$ contact to the case and tested to $\pm 2\text{kV}$ contact to I/O terminals. 10 times. Grounding.

Note: The microphone sensitivity after stress must deviate by no more than $\pm 3\text{dB}$ from the initial value.

13. VERSION HISTORY:

Version	Description	Date
1.0	Initial release	2024.04